

Toshiba Bipolar Digital Integrated Circuit Silicon Monolithic

TD62081APG,TD62081AFG,TD62082APG,TD62082AFG, TD62083APG,TD62083AFG,TD62084APG,TD62084AFG

8ch Darlington Sink Driver

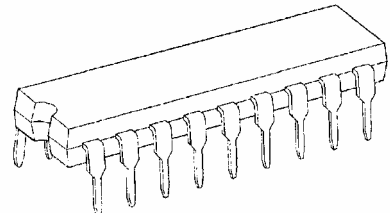
The TD62081APG/AFG Series are high-voltage, high-current darlington drivers comprised of eight NP darlington pairs. All units feature integral clamp diodes for switching inductive loads. Applications include relay, hammer, lamp and display (LED) drivers.

Features

- Output current (single output)
500 mA (max) (TD62081APG/AFG series)
- High sustaining voltage output
50 V (min) (TD62081APG/AFG series)
- Output clamp diodes
- Inputs compatible with various types of logic.
- Package type-APG: DIP-18 pin
- Package type-AFG: SOP-18 pin

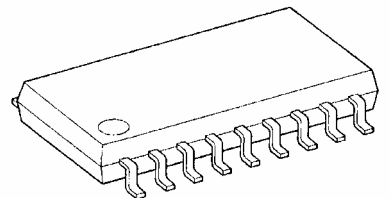
Type	Input Base Resistor	Designation
TD62081APG/AFG	External	General purpose
TD62082APG/AFG	10.5-k Ω + 7 V Zener diode	14 V to 25 V PMOS
TD62083APG/AFG	2.7 k Ω	TTL, 5 V CMOS
TD62084APG/AFG	10.5 k Ω	6 V to 15 V PMOS, CMOS

TD62081APG, TD62082APG
TD62083APG, TD62084APG



DIP18-P-300-2.54D

TD62081AFG, TD62082AFG
TD62083AFG, TD62084AFG



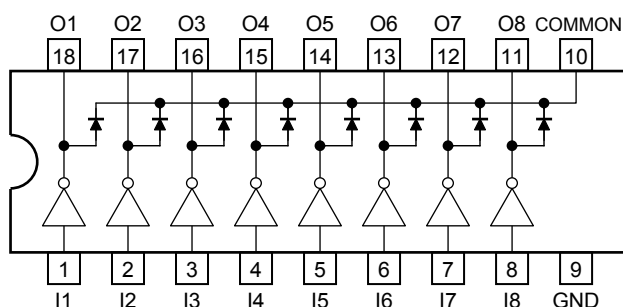
SOP18-P-375-1.27

Weight

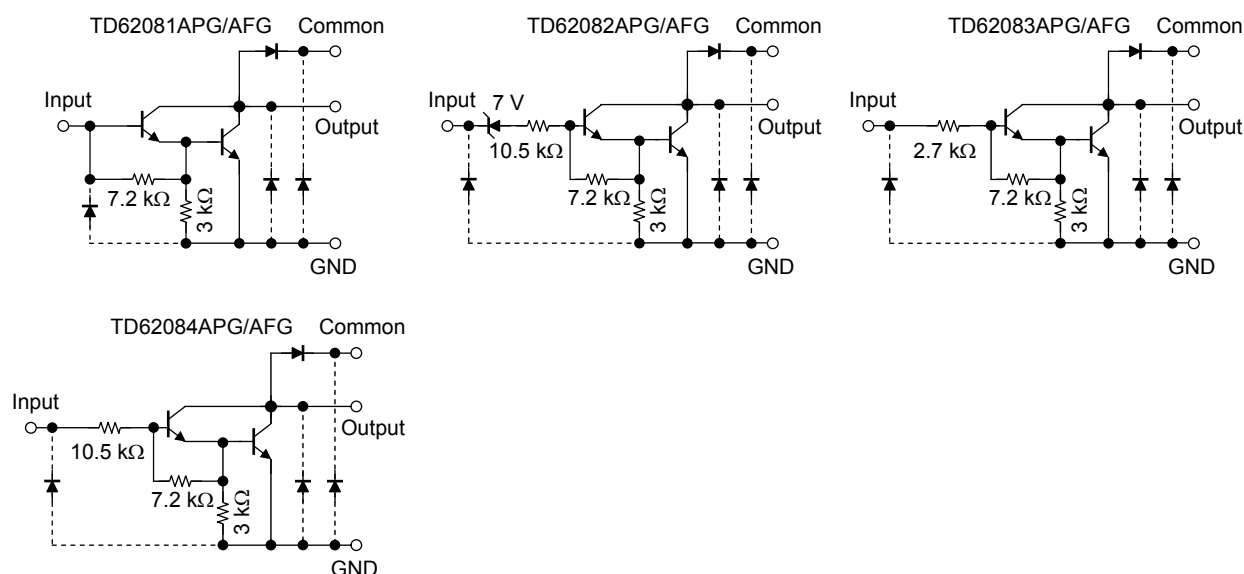
DIP18-P-300-2.54D: 1.47 g (typ.)

SOP18-P-375-1.27 : 0.41 g (typ.)

Pin Connection (top view)



Schematics (each driver)



Note: The input and output parasitic diodes cannot be used as clamp diodes.

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit
Output sustaining voltage		$V_{CE(SUS)}$	-0.5 to 50	V
Output current		I_{OUT}	500	mA/ch
Input voltage		V_{IN} (Note 1)	-0.5 to 30	V
Input current		I_{IN} (Note 2)	25	mA
Clamp diode reverse voltage		V_R	50	V
Clamp diode forward current		I_F	500	mA
Power dissipation	APG	P_D	1.47	W
	AFG		0.96	
Operating temperature		T_{opr}	-40 to 85	°C
Storage temperature		T_{stg}	-55 to 150	°C

Note 1: Except TD62081APG/AFG

Note 2: Only TD62081APG/AFG

Recommended Operating Conditions (Ta = -40 to 85°C)

Characteristics		Symbol	Test Condition	Min	Typ.	Max	Unit
Output sustaining voltage		V _{CE} (SUS)		0	—	50	V
Output current	APG	I _{OUT}	T _{pw} = 25 ms, Duty = 10% 8 circuits	0	—	347	mA/ch
			T _{pw} = 25 ms, Duty = 50% 8 circuits	0	—	123	
	AFG		T _{pw} = 25 ms, Duty = 10% 8 circuits	0	—	268	
			T _{pw} = 25 ms, Duty = 50% 8 circuits	0	—	90	
Input voltage	Except TD62081APG/AFG	V _{IN}		0	—	30	V
Input voltage (Output on)	TD62082APG/AFG	V _{IN} (ON)		14	—	30	V
	TD62083APG/AFG			2.5	—	30	
	TD62084APG/AFG			8	—	30	
Input voltage (Output off)	TD62082APG/AFG	V _{IN} (OFF)		0	—	7.4	V
	TD62083APG/AFG			0	—	0.5	
	TD62084APG/AFG			0	—	1.0	
Input current	Only TD62081APG/AFG	I _{IN}		0	—	5	mA
Clamp diode reverse voltage		V _R		—	—	50	V
Clamp diode forward current		I _F		—	—	400	mA
Power dissipation	APG	P _D		—	—	0.52	W
	AFG			—	—	0.4	

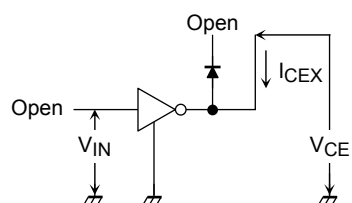
Electrical Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Circuit	Test Condition	Min	Typ.	Max	Unit
Output leakage current	I _{CEX}	1	V _{CE} = 50 V	Ta = 25°C	—	50	μA
				Ta = 85°C	—	100	
				V _{IN} = 6 V	—	500	
				V _{IN} = 1 V	—	500	
Collector-emitter saturation voltage	V _{CE (sat)}	2	I _{OUT} = 350 mA, I _{IN} = 500 μA	—	1.3	1.6	V
			I _{OUT} = 200 mA, I _{IN} = 350 μA	—	1.1	1.3	
			I _{OUT} = 100 mA, I _{IN} = 250 μA	—	0.9	1.1	
Input current	I _{IN (ON)}	2	V _{IN} = 17 V	—	0.82	1.25	mA
			V _{IN} = 3.85 V	—	0.93	1.35	
			V _{IN} = 5 V	—	0.35	0.5	
			V _{IN} = 12 V	—	1.0	1.45	
	I _{IN (OFF)}	4	I _{OUT} = 500 μA, Ta = 85°C	50	65	—	μA
Input voltage (Output on)	V _{IN (ON)}	5	V _{CE} = 2 V, I _{OUT} = 300 mA	—	—	13	V
			V _{CE} = 2 V, I _{OUT} = 200 mA	—	—	2.4	
			V _{CE} = 2 V, I _{OUT} = 250 mA	—	—	2.7	
			V _{CE} = 2 V, I _{OUT} = 300 mA	—	—	3.0	
			V _{CE} = 2 V, I _{OUT} = 125 mA	—	—	5.0	
			V _{CE} = 2 V, I _{OUT} = 200 mA	—	—	6.0	
			V _{CE} = 2 V, I _{OUT} = 275 mA	—	—	7.0	
			V _{CE} = 2 V, I _{OUT} = 350 mA	—	—	8.0	
DC current transfer ratio	h _{FE}	2	V _{CE} = 2 V, I _{OUT} = 350 mA	1000	—	—	
Clamp diode reverse current	I _R	6	Ta = 25°C (Note)	—	—	50	μA
			Ta = 85°C (Note)	—	—	100	
Clamp diode forward voltage	V _F	7	I _F = 350 mA	—	—	2.0	V
Input capacitance	C _{IN}	—		—	15	—	pF
Turn-on delay	t _{ON}	8	R _L = 125 Ω, V _{OUT} = 50 V	—	0.1	—	μs
Turn-off delay	t _{OFF}		R _L = 125 Ω, V _{OUT} = 50 V	—	0.2	—	

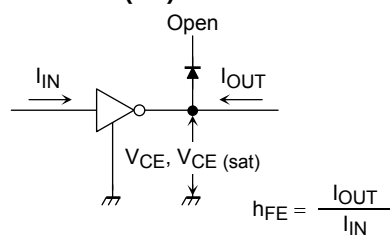
 Note: V_R = V_R max

Test Circuit

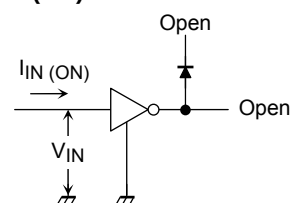
1. I_{CEX}



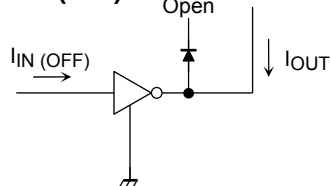
2. $V_{CE} (sat)$, h_{FE}



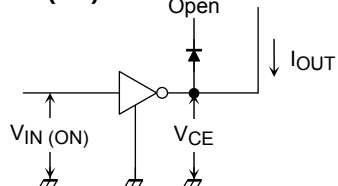
3. $I_{IN} (ON)$



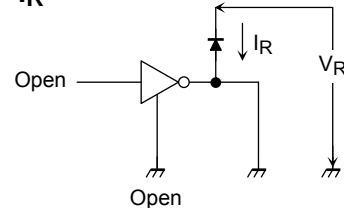
4. $I_{IN} (OFF)$



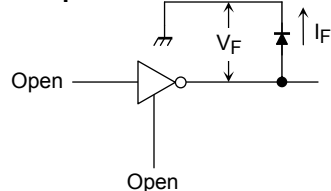
5. $V_{IN} (ON)$



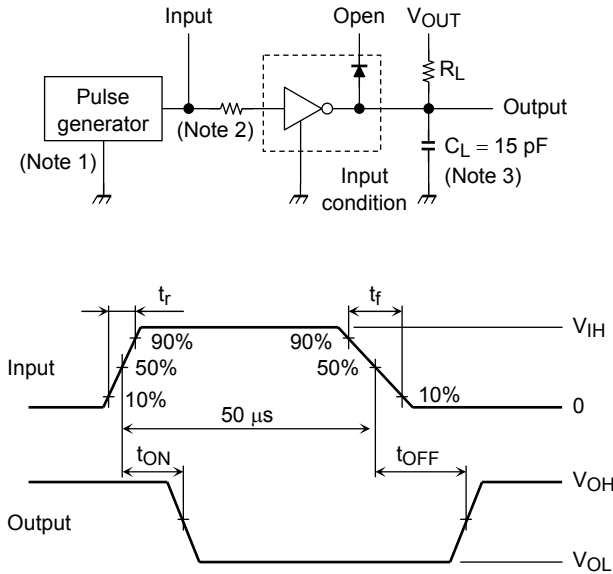
6. I_R



7. V_F



8. t_{ON} , t_{OFF}



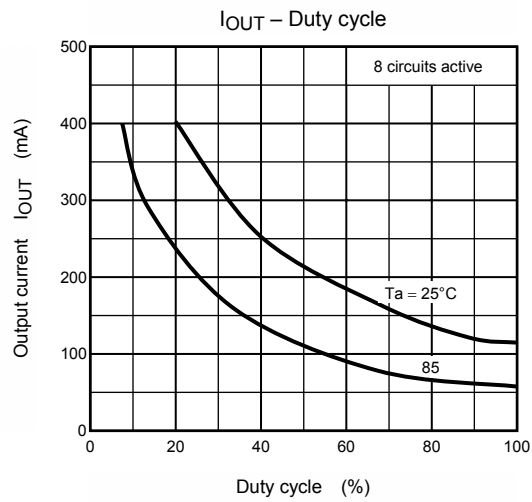
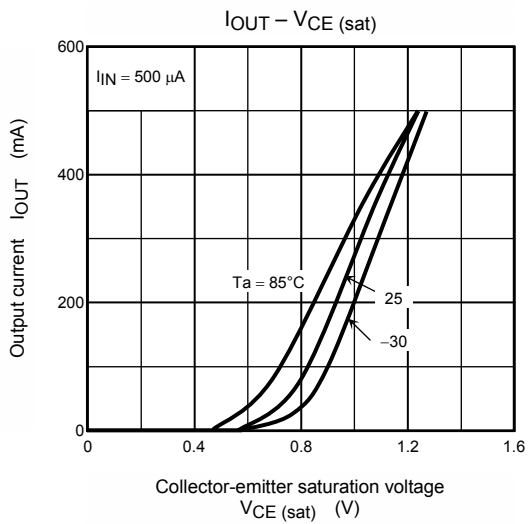
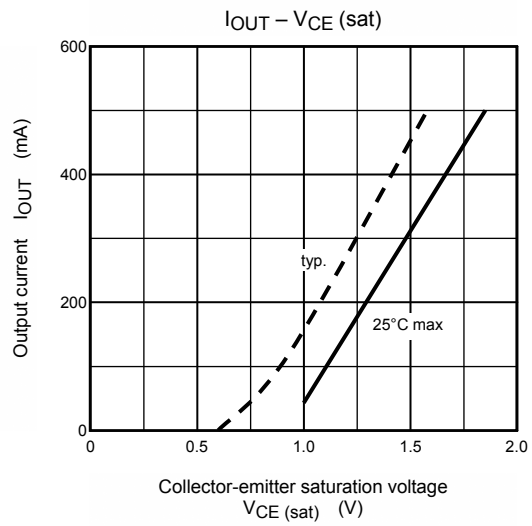
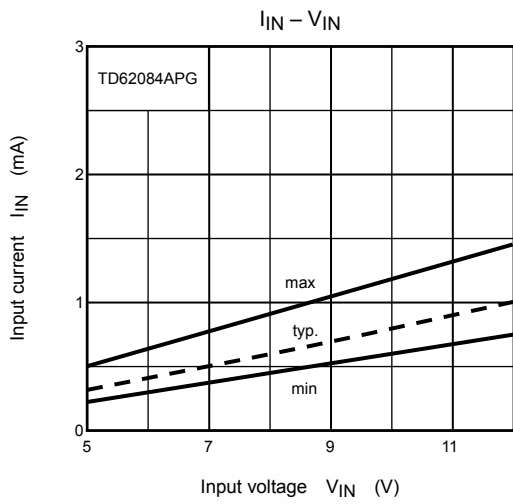
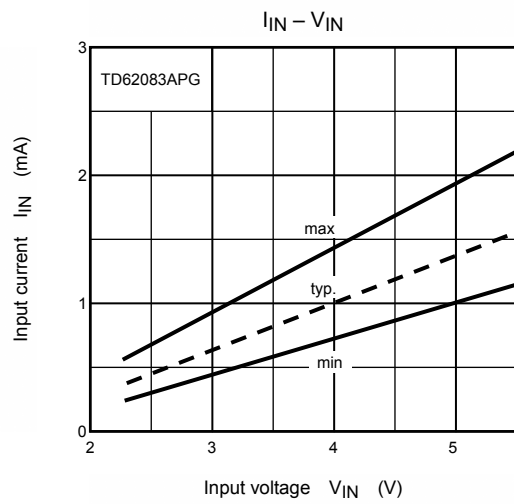
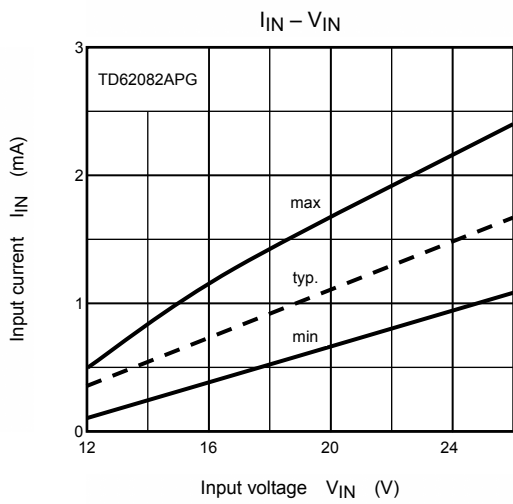
Note 1: Pulse width $50\text{ }\mu\text{s}$, duty cycle 10%
Output impedance $50\text{ }\Omega$, $t_r \leq 5\text{ ns}$, $t_f \leq 10\text{ ns}$
Note 2: See below.
Input condition

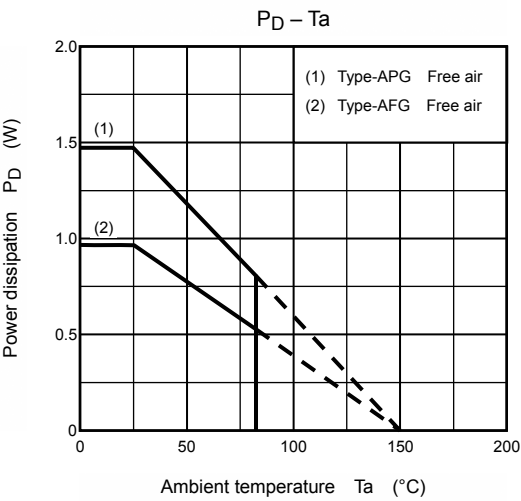
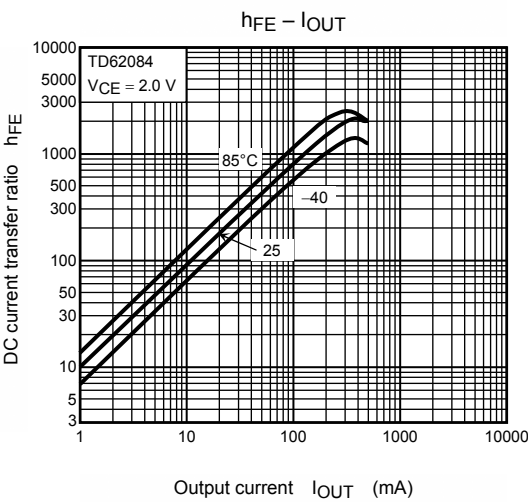
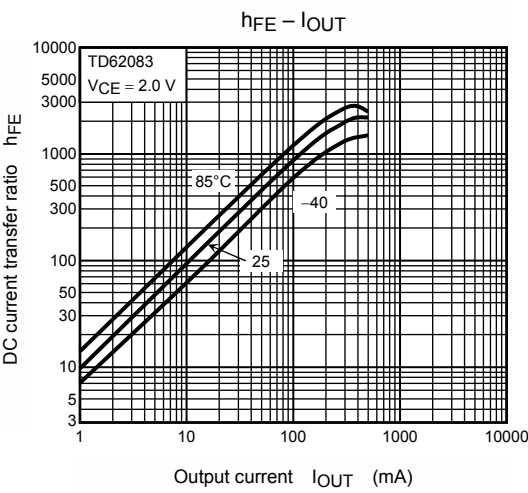
Type Number	R1	V_{IH}
TD62081APG/AFG	$2.7\text{ k}\Omega$	3 V
TD62082APG/AFG	$0\text{ }\Omega$	13 V
TD62083APG/AFG	$0\text{ }\Omega$	3 V
TD62084APG/AFG	$0\text{ }\Omega$	8 V

Note 3: C_L includes probe and jig capacitance

Precautions for Using

This IC does not include built-in protection circuits for excess current or overvoltage.
If this IC is subjected to excess current or overvoltage, it may be destroyed.
Hence, the utmost care must be taken when systems which incorporate this IC are designed.
Utmost care is necessary in the design of the output line, COMMON and GND line since IC may be destroyed due to short-circuit between outputs, air contamination fault, or fault by improper grounding.

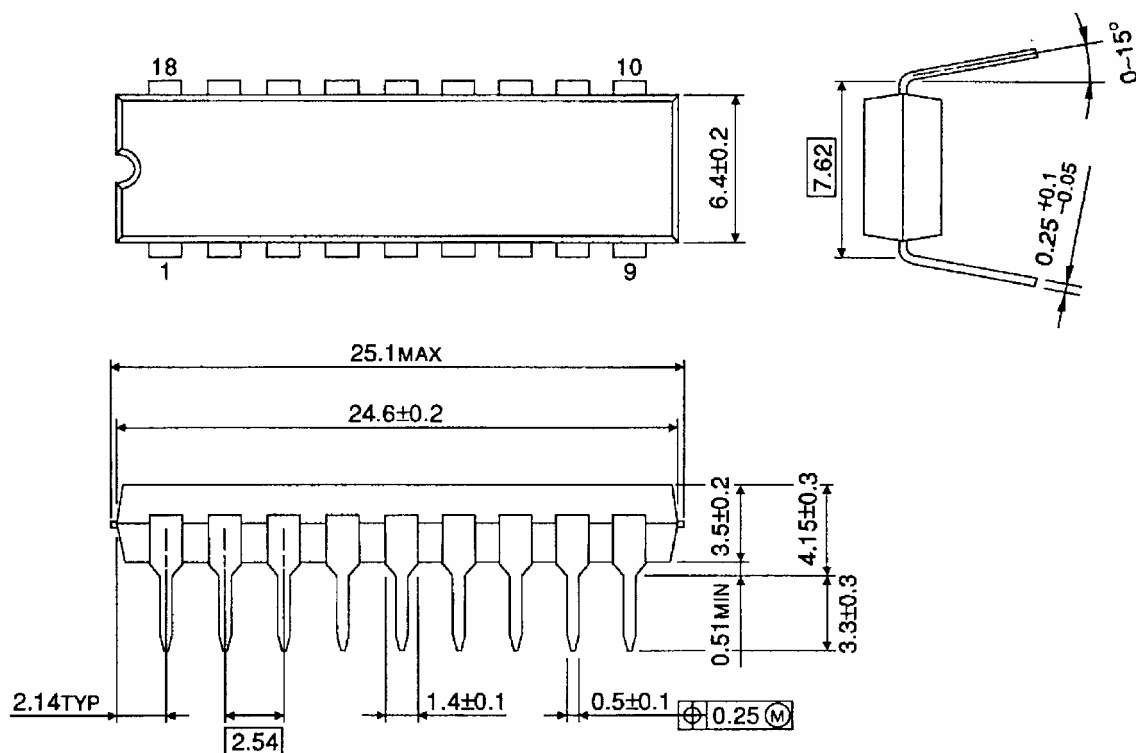




Package Dimensions

DIP18-P-300-2.54D

Unit : mm

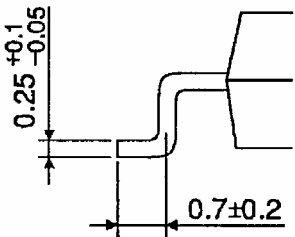
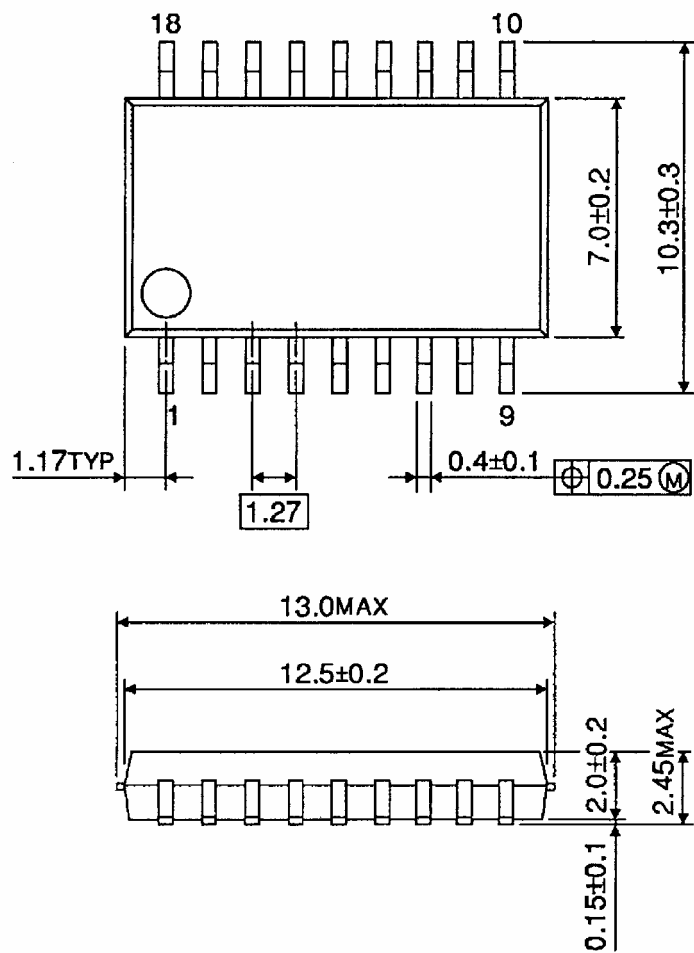


Weight: 1.47 g (typ.)

Package Dimensions

SOP18-P-375-1.27

Unit : mm



Weight: 0.41 g (typ.)

About solderability, following conditions were confirmed

- Solderability

- (1) Use of Sn-63Pb solder Bath
 - solder bath temperature = 230°C
 - dipping time = 5 seconds
 - the number of times = once
 - use of R-type flux
- (2) Use of Sn-3.0Ag-0.5Cu solder Bath
 - solder bath temperature = 245°C
 - dipping time = 5 seconds
 - the number of times = once
 - use of R-type flux

RESTRICTIONS ON PRODUCT USE

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